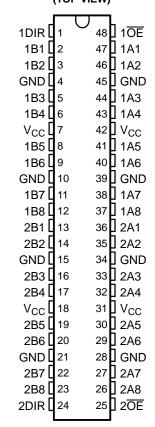
SN54ABT16245A, SN74ABT16245A 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS300G-MARCH 1994-REVISED JANUARY 2006

FEATURES

- Members of the Texas Instruments Widebus™ Family
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- Typical V_{OLP} (Output Ground Bounce) <1 V at V_{CC} = 5 V, T_A = 25°C
- High-Impedance State During Power Up and Power Down
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (-32-mA I_{OH}, 64-mA I_{OL})
- Latch-Up Performance Exceeds 500 mA Per JESD 70
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Includes Plastic Thin Very Small-Outline (DGV), Shrink Small-Outline (DL), and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic (WD) Flat Package Using 25-mil Center-to-Center Spacings

SN54ABT16245A... WD PACKAGE SN74ABT16245A... DGG, DGV, OR DL PACKAGE (TOP VIEW)



DESCRIPTION

The 'ABT16245A devices are 16-bit noninverting 3-state transceivers designed for synchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements.

These devices can be used as two 8-bit transceviers or one 16-bit transceiver. They allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so that the buses are effectively isolated.

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impendance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT16245A is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ABT16245A is characterized for operation from -40°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

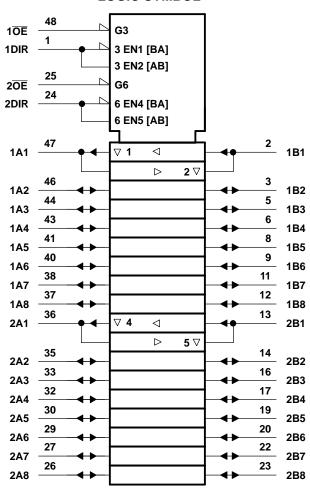
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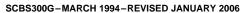
FUNCTION TABLE (EACH 8-BIT SECTION)

INP	UTS	OPERATION
ŌĒ	DIR	OPERATION
L	L	B data to A bus
L	Н	A data to B bus
Н	Χ	Isolation

LOGIC SYMBOL(1)

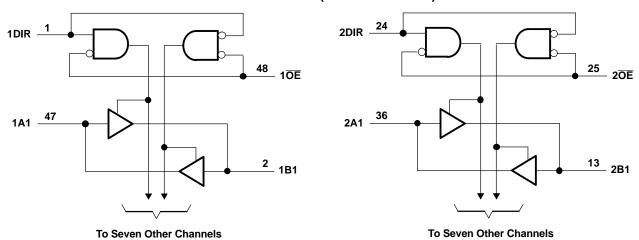


(1) This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.





LOGIC DIAGRAM (POSITIVE LOGIC)



Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

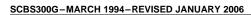
			MIN	MAX	UNIT	
V_{CC}	Supply voltage range		-0.5	7	٧	
VI	Input voltage range (except I/O ports) ⁽²⁾				V	
Vo	Voltage range applied to any output in the high of	-0.5	5.5	V		
	Compart into any system tip the law state	SN54ABT16245A			A	
IO	Current into any output in the low state	SN74ABT16245A		128	mA	
I _{IK}	Input clamp current	V _I < 0		-18	mA	
I _{OK}	Output clamp current	V _O < 0		-50	mA	
		DGG package		89		
θ_{JA}	Package thermal impedance (3)	DGV package		93	°C/W	
		DL package		94		
T _{stg}	Storage temperature range		-65	150	°C	

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

⁽²⁾ The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

⁽³⁾ The package thermal impedance is calculated in accordance with JESD 51.

SN54ABT16245A, SN74ABT16245A 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS





Recommended Operating Conditions⁽¹⁾

			SN54ABT	16245A	SN74ABT	16245A	UNIT
			MIN	MAX	MIN	MAX	UNIT
V _{CC}	Supply voltage	Supply voltage				5.5	V
V _{IH}	High-level input voltage	2		2		V	
V_{IL}	Low-level input voltage		0.8		0.8	V	
VI	Input voltage	0	V_{CC}	0	V_{CC}	V	
I _{OH}	High-level output current			-24		-32	mA
I _{OL}	Low-level output current			48		64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
$\Delta t/\Delta V_{CC}$	Power-up ramp rate	200		200		μs/V	
T _A	Operating free-air temperature	-55	125	-40	85	°C	

⁽¹⁾ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

DAD	AMETER	TEST OF	NUDITIONS	7	Γ _A = 25°0	;	SN54ABT	16245A	SN74ABT16245A		
PARA	AMETER	TEST CO	ONDITIONS	MIN	TYP ⁽¹⁾	MAX	MIN	MAX	MIN	MAX	UNIT
V _{IK}		V _{CC} = 4.5 V,	$I_I = -18 \text{ mA}$			-1.2		-1.2		-1.2	V
		$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -3 \text{ mA}$	2.5			2.5		2.5		
.,		V _{CC} = 5 V,	$I_{OH} = -3 \text{ mA}$	3			3		3		V
V _{OH}		\/ 45\/	$I_{OH} = -24 \text{ mA}$	2			2				V
		V _{CC} = 4.5 V	$I_{OH} = -32 \text{ mA}$	2(2)					2		
		V 45.V	I _{OL} = 48 mA			0.55		0.55			V
V_{OL}		$V_{CC} = 4.5 \text{ V}$	I _{OL} = 64 mA			0.55(2)				0.55	V
V _{hys}					100						mV
	Control inputs $V_{CC} = 0$ to 5.5 V, $V_I = V_{CC}$		√ _{CC} or GND			±1		±1		±1	
I _I	A or B port	V _{CC} = 2.1 V to 5.5 V, V	' _I = V _{CC} or GND			±20 ⁽²⁾		±100		±20	μΑ
l _{OZPU}	1	$V_{CC} = 0 \text{ to } 2.1 \text{ V, } V_{O} =$	0.5 V to 2.7 V, OE = X			±50(3)		±50 ⁽³⁾		±50	μΑ
I _{OZPD}		$V_{CC} = 2.1 \text{ V to 0, } V_{O} =$	0.5 V to 2.7 V, OE = X			±50(3)		±50 ⁽³⁾		±50	μΑ
I _{OZH} ⁽⁴⁾	(4) $V_{CC} = 2.1 \text{ V to } 5.5 \text{ V}, V_{O} = 2.7 \text{ V}, \overline{OE} \ge 2 \text{ V}$					10 ⁽⁵⁾		10		10 ⁽⁵⁾	μΑ
I _{OZL} ⁽⁴⁾		$V_{CC} = 2.1 \text{ V to } 5.5 \text{ V}, V_{O} = 0.5 \text{ V}, OE \ge 2 \text{ V}$				-10 ⁽⁵⁾		-10		-10 ⁽⁵⁾	μΑ
I _{off}		$V_{CC} = 0$,	V_I or $V_O \le 5.5 \text{ V}$			±100				±100	μΑ
I _{CEX}		V _{CC} = 5.5 V, V _O = 5.5 V	Outputs high			50		50		50	μΑ
I _O ⁽⁶⁾		V _{CC} = 5.5 V,	V _O = 2.5 V	-50	-100	-180	-50	-180	-50	-180	mA
	_		Outputs high			2		2		2	
I_{CC}	A or B port	$V_{CC} = 5.5 \text{ V}, I_{O} = 0,$ $V_{I} = V_{CC} \text{ or GND}$	Outputs low			32		32		32	mA
	Port	1 100 0.15	Outputs disabled			2		2		2	
		$V_{CC} = 5.5 \text{ V},$	Outputs enabled			2		1.5		2	
Δl _{CC} ⁽⁷⁾	Data inputs	One inputs at 3.4 V, Other inputs at V _{CC} or GND	Outputs disabled			0.05		1		0.05	mA
	Control inputs	V _{CC} = 5.5 V, One input	$V_{CC} = 5.5 \text{ V}$, One input at 3.4 V, Other inputs at V_{CC} or GND			1.5		1.5		1.5	
Ci	Control inputs	V _I = 2.5 V or 0.5 V			3						pF
C _o	A or B port	V _O = 2.5 V or 0.5 V			6						pF

- All typical values are at V_{CC} = 5 V. On products compliant to MIL-PRF-38535, this parameter does not apply. On products compliant to MIL-PRF-38535, this parameter is not production tested.
- The parameters I_{OZH} and I_{OZL} include the input leakage current.
- This limit may vary among suppliers.
- (6) Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
- This is the increase in supply current for each input that is at the specified TTL voltage level, rather than V_{CC} or GND.

SN54ABT16245A, SN74ABT16245A 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS300G-MARCH 1994-REVISED JANUARY 2006



Switching Characteristics

over recommended operating ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

				SN54ABT16245A					
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _C	_{CC} = 5 V _A = 25°C	,	MIN	MAX	UNIT	
			MIN	TYP	MAX				
t _{PLH}	A or B	B or A	0.5	2.2	3.4	0.5	4	no	
t _{PHL}	AUID	BUIA	0.5	2.3	3.8	0.5	4.6	ns	
t _{PZH}	OE	B or A	0.8	3.6	5.2	0.8	5.5	no	
t _{PZL}	OE	BULA	0.9	3.7	6.1	0.1	7.3	ns	
t _{PHZ}	OE	B or A	1.3	4.4	5.8	1.3	6.3	ne	
t _{PLZ}	OE .	B OF A	1.4	3.3	4.7	1.4	5.5	ns	

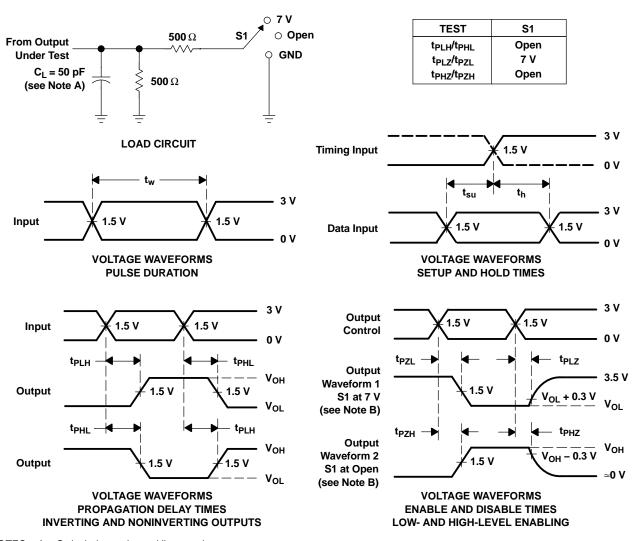
Switching Characteristics

over recommended operating ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

			SN74ABT16245A					
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 5 V, T _A = 25°C MIN				MAX	UNIT
			MIN	TYP	MAX			
t _{PLH}	A or B	A or B B or A		2.2	3.4	1	3.9	2
t _{PHL}	AUID	BULA	1	2.3	3.7	1	4.2	ns
t _{PZH}	OE	B or A	1	3.6	5.2	1	6.3	20
t _{PZL}	OL	BULK	1	3.7	5.4	1	6.4	ns
t _{PHZ}	<u> </u>	B or A	2	4.4	5.8	2	6.3	ns
t _{PLZ}	ŌĒ	BULA	1.5	3.3	4.7	1.5	5.2	115



PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50~\Omega$, $t_f \leq$ 2.5 ns, $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time, with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





9-Oct-2020

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-9317501MXA	ACTIVE	CFP	WD	48	1	TBD	SNPB	N / A for Pkg Type	-55 to 125	5962-9317501MX A SNJ54ABT16245A WD	Samples
74ABT16245ADGGRG4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABT16245A	Samples
SN74ABT16245ADGGR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABT16245A	Samples
SN74ABT16245ADGVR	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AH245A	Samples
SN74ABT16245ADL	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABT16245A	Samples
SN74ABT16245ADLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABT16245A	Samples
SNJ54ABT16245AWD	ACTIVE	CFP	WD	48	1	TBD	SNPB	N / A for Pkg Type	-55 to 125	5962-9317501MX A SNJ54ABT16245A WD	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



PACKAGE OPTION ADDENDUM

9-Oct-2020

- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54ABT16245A, SN74ABT16245A:

Catalog: SN74ABT16245A

Enhanced Product: SN74ABT16245A-EP, SN74ABT16245A-EP

Military: SN54ABT16245A

NOTE: Qualified Version Definitions:

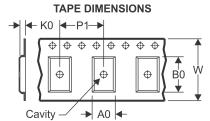
- Catalog TI's standard catalog product
- Enhanced Product Supports Defense, Aerospace and Medical Applications
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

www.ti.com 11-Mar-2017

TAPE AND REEL INFORMATION





Α0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABT16245ADGGR	TSSOP	DGG	48	2000	330.0	24.4	8.6	13.0	1.8	12.0	24.0	Q1
SN74ABT16245ADGVR	TVSOP	DGV	48	2000	330.0	16.4	7.1	10.2	1.6	12.0	16.0	Q1
SN74ABT16245ADLR	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1

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*All dimensions are nominal

7 til diritoriorerio di e ricitima:							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ABT16245ADGGR	TSSOP	DGG	48	2000	367.0	367.0	45.0
SN74ABT16245ADGVR	TVSOP	DGV	48	2000	367.0	367.0	38.0
SN74ABT16245ADLR	SSOP	DL	48	1000	367.0	367.0	55.0

WD (R-GDFP-F**)

CERAMIC DUAL FLATPACK

48 LEADS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only
- E. Falls within MIL STD 1835: GDFP1-F48 and JEDEC MO-146AA

GDFP1-F56 and JEDEC MO-146AB

DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

DL (R-PDSO-G48)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

PowerPAD is a trademark of Texas Instruments.



DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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